

# RClamp0572ZC

Femto Farad RailClamp® 2-Line, 300fF ESD Protection

### Description

RClamp®0572ZC is an ultra low capacitance ESD protection device designed to protect two high-speed lines in an 0201 footprint. This revolutionary package design reduces board space requirements by more than 50% over existing single line solutions. RClamp0572ZC is a three pin device with identical low capacitance TVS diodes connected to each pin. Any two pins may be connected to high-speed lines, while the third pin is connected to ground. This gives the designer maximum flexibility in pcb routing. Each line has a maximum capacitance of only 0.3pF resulting in a typical corner frequency of 16GHz.

RClamp0572ZC is in a 3-pin SLP0603P3X3C package. It measures 0.62 x 0.32 mm with a nominal height of only 0.25mm. Leads are finished with lead-free NiAu. The combination of small size and low capacitance makes them ideal for use in portable applications such as cellular phones, digital cameras, and tablets.

### Features

- High ESD withstand voltage
  - IEC 61000-4-2 (ESD) 15kV (air), 10kV (contact)
- Ultra-small 0201package
- Working voltage: 5V
- Protects two high-speed data lines
- Low reverse leakage current: <5nA (Typ.) at  $V_{R}=5V$
- Low capacitance: 0.3pF (Max.)
- Dynamic resistance: 0.54 Ohms (Typ.)
- Solid-state silicon-avalanche technology

### **Mechanical Characteristics**

- SLP0603P3X3C package
- Pb-Free, Halogen Free, RoHS/WEEE Compliant
- Nominal Dimensions: 0.62 x 0.32 x 0.25 mm
- Lead Finish: NiAu
- Marking : Marking code
- Packaging : Tape and Reel

### **Applications**

- USB Type-C
- USB 3.0
- USB 3.1

### **Nominal Dimensions**



### **Functional Schematic**



Rev 2.1 08/08/2023 www.semtech.com

### **Absolute Maximum Ratings**

Rating	Symbol	Value	Units
Peak Pulse Power (tp = $8/20\mu$ s)	Р <sub>рк</sub>	42	W
Peak Pulse Current (tp = $8/20\mu s$ )	I <sub>pp</sub>	3	А
ESD per IEC 61000-4-2 (Air) <sup>(1) (2)</sup> ESD per IEC 61000-4-2 (Contact) <sup>(1) (2)</sup>	V <sub>ESD</sub>	±15 ±10	kV
Operating Temperature	T,	-40 to +85	°C
Storage Temperature	T <sub>stg</sub>	-55 to +150	°C

### **Electrical Characteristics (T=25°C unless otherwise specified)**

Parameter	Symbol	Conditions		Min.	Тур.	Max.	Units
Reverse Stand-Off Voltage	V <sub>RWM</sub>	Between any two pins, T= -40 °C to +85 °C				5	V
Reverse Breakdown Voltage	V <sub>BR</sub>	$I_t = 1 \text{ mA}$ , between any two pins		7	9	11	V
Reverse Leakage Current	I <sub>R</sub>	V <sub>RWM</sub> = 5V, between any two pins			<5	50	nA
		$t_{p} = 8/20 \mu s$ ,	$I_{PP} = 1A$		10.4	12	
Clamping Voltage	ng Voltage $V_{c}$ between any two pins	$I_{PP} = 3A$		12	14		
FCD Claure in a Vialta and			$I_{PP} = 4A$		12	V	V
ESD Clamping Voltage <sup>3</sup>	V <sub>C</sub>		I <sub>PP</sub> = 16A		20		V
Dynamic Resistance <sup>3, 4</sup>	R <sub>dyn</sub>	t <sub>p</sub> = 0.2/100ns (TLP), Pin 1 to 2, Pin 3 to 2			0.54		Ω
Junction Capacitance	C,	$V_{R} = 0V, f = 1MHz,$ between any two pins			0.22	0.30	pF

Notes:

(1): ESD Gun return path to Ground Reference Plane (GRP)

(2): In-System ESD withstand voltage

(3): Transmission Line Pulse Test (TLP) Settings:  $t_p = 100ns$ ,  $t_r = 0.2ns$ ,  $I_{TLP}$  and  $V_{TLP}$  averaging window:  $t_1 = 70ns$  to  $t_2 = 90ns$ .

(4): Dynamic resistance calculated from  $I_{TLP} = 4A$  to  $I_{TLP} = 16A$ 

### **Typical Characteristics**

ESD Clamping (+8kV Contact per IEC 61000-4-2)



TLP IV Curve (Positive Pulse)



Capacitance vs. Reverse Voltage



ESD Clamping (-8kV Contact per IEC 61000-4-2)



**TLP IV Curve (Negative Pulse)** 



Clamping Voltage vs. Peak Pulse Current (tp=8/20µs)



#### RClamp0572ZC Final Datasheet Revision Date

Rev 2.1 08/08/2023 www.semtech.com

# **Typical Characteristics (Continued)**





### **Applications Information**

### **Assembly Guidelines**

The small size of this device means that some care must be taken during the mounting process to insure reliable solder joint. The figure at the right details Semtech's recommended mounting pattern. Recommended assembly guidelines are shown in Table 1. Note that these are only recommendations and should serve only as a starting point for design since there are many factors that affect the assembly process. Exact manufacturing parameters will require some experimentation to get the desired solder application. Semtech's recommended mounting pattern is based on the following design guidelines:

#### Land Pattern

The recommended land pattern follows IPC standards and is designed for maximum solder coverage. Detailed dimensions are shown elsewhere in this document.

#### **Solder Stencil**

Stencil design is one of the key factors which will determine the volume of solder paste which is deposited onto the land pad. The area ratio of the stencil aperture will determine how well the stencil will print. The area ratio takes into account the aperture shape, aperture size, and stencil thickness. An area ratio of 0.70 – 0.75 is preferred for the subject package. The area ratio of a rectangular aperture is given as:

Area Ratio = (L \* W) / (2 \* (L + W) \* T)

Where: L = Aperture Length W = Aperture Width T = Stencil Thickness

Semtech recommends a stencil thickness of 0.100mm for this device. The stencil should be laser cut with electropolished finish. The stencil should have a positive taper of approximately 5 degrees. Electro polishing and tapering the walls results in reduced surface friction and better paste release. For small pitch components, Semtech recommends a square aperture with rounded corners for consistent solder release. Due to the small aperture size, a solder paste with Type 4 or smaller particles are recommended.

#### **Recommended Mounting Pattern**



Table 1 - Recommended Assembly Guidelines				
Assembly Parameter	Recommendation			
Solder Stencil Design	Laser Cut, Electro-Polished			
Aperture Shape	Rectangular with rounded corners			
Solder Stencil Thickness	0.100mm (0.004")			
Solder Paste Type	Type 4 size sphere or smaller			
Solder Reflow Profile	Per JEDEC J-STD-020			
PCB Solder pad Design	Non-Solder Mask Defined			
PCB Pad Finish	OSP or NiAu			

### Outline Drawing - SLP0603P3X3C



### Land Pattern - SLP0603P3X3C



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### **Marking Code**



Notes: Device is electrically symmetrical

# **Tape and Reel Specification**



## **Ordering Information**

Part Number	Qty per Reel	Reel Size		
RClamp0572ZCTFT	15000	7 Inch		
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8 of 8 Semtech **Proprietary & Confidential**